# onsemi

# 6-Pin General Purpose Phototransistor Optocouplers

# 4N25M, 4N26M, 4N27M, 4N28M, 4N35M, 4N36M, 4N37M

#### Description

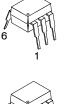
The general purpose optocouplers consist of a gallium arsenide infrared emitting diode driving a silicon phototransistor in a standard plastic 6-pin dual-in-line package.

#### Features

- Minimum Current Transfer Ratio at  $I_F = 10 \text{ mA}$ ,  $V_{CE} = 10 \text{ V}$ :
  - 10% for 4N27M and 4N28M
  - ◆ 20% for 4N25M and 4N26M
  - 100% for 4N35M and 4N36M and 4N37M
- Safety and Regulatory Approvals:
  - UL1577, 4,170 VAC<sub>RMS</sub> for 1 Minute
  - DIN-EN/IEC60747-5-5, 850 V Peak Working Insulation Voltage

#### Applications

- Power Supply Regulators
- Digital Logic Inputs
- Microprocessor Inputs



CASE 646BX

PDIP6



PDIP6 S SUFFIX CASE 646BY



PDIP6 T SUFFIX CASE 646BZ

#### MARKING DIAGRAM



ON = Logo

v

Q

4N25 = Specific Device Code

- DIN EN/IEC60747-5-5 Option (only appears on component ordered with this option)
- X = One-Digit Year Code
- YY = Digit Work Week
  - = Assembly Package Code

ANODE 1 ANODE 1 CATHODE 2 N/C 3 ANODE 4 EMITTER

#### **ORDERING INFORMATION**

See detailed ordering and shipping information on page 8 of this data sheet.

**SAFETY AND INSULATION RATINGS** (As per DIN EN/IEC 60747–5–5, this optocoupler is suitable for "safe electrical insulation" only within the safety limit data. Compliance with the safety ratings shall be ensured by means of protective circuits.)

Parameter		Characteristics
Installation Classifications per DIN VDE 0110/1.89 Table 1,	<150 V <sub>RMS</sub>	I–IV
For Rated Mains Voltage <300 V <sub>RMS</sub>		I–IV
Climatic Classification	55/100/21	
Pollution Degree (DIN VDE 0110/1.89)		2
Comparative Tracking Index	175	

Symbol	Parameter	Value	Unit
V <sub>PR</sub>	Input-to-Output Test Voltage, Method A, $V_{IORM} x 1.6 = V_{PR}$ , Type and Sample Test with $t_m = 10$ s, Partial Discharge < 5 pC	1360	V <sub>peak</sub>
	Input-to-Output Test Voltage, Method B, $V_{IORM} x 1.875 = V_{PR}$ , 100% Production Test with $t_m = 1$ s, Partial Discharge < 5 pC	1594	V <sub>peak</sub>
V <sub>IORM</sub>	Maximum Working Insulation Voltage	850	V <sub>peak</sub>
V <sub>IOTM</sub>	Highest Allowable Over-Voltage	6000	V <sub>peak</sub>
	External Creepage	≥7	mm
	External Clearance	≥7	mm
	External Clearance (for Option TV, 0.4" Lead Spacing)	≥10	mm
DTI	Distance Through Insulation (Insulation Thickness)	≥0.5	mm
Τ <sub>S</sub>	Case Temperature (Note 1)	175	°C
I <sub>S,INPUT</sub>	Input Current (Note 1)	350	mA
P <sub>S,OUTPUT</sub>	Output Power (Note 1)	800	mW
R <sub>IO</sub>	Insulation Resistance at T <sub>S</sub> , V <sub>IO</sub> = 500 V (Note 1)	>10 <sup>9</sup>	Ω

1. Safety limit values - maximum values allowed in the event of a failure.

#### **ABSOLUTE MAXIMUM RATINGS**

Symbol	Parameter	Мах	Unit
OTAL DEV	ICE	· · · · · · · · · · · · · · · · · · ·	
T <sub>STG</sub>	Storage Temperature	-40 to +125	°C
T <sub>OPR</sub>	Operating Temperature	-40 to +100	°C
ТJ	Junction Temperature	-40 to +125	°C
T <sub>SOL</sub>	Lead Solder Temperature	260 for 10 seconds	°C
PD	Total Device Power Dissipation @ $T_A = 25^{\circ}C$	270	mW
	Derate Above 25°C	2.94	mW/°C
MITTER			
١ <sub>F</sub>	DC / Average Forward Input Current	60	mA
V <sub>R</sub>	Reverse Input Voltage	6	V
IF <sup>(pk)</sup>	Forward Current – Peak (300 µs, 2% Duty Cycle)	3	А
PD	LED Power Dissipation @ T <sub>A</sub> = 25°C	120	mW
	Derate Above 25°C	1.41	mW/°C
ETECTOR			
V <sub>CEO</sub>	Collector-to-Emitter Voltage	30	V
V <sub>CBO</sub>	Collector-to-Base Voltage	70	V
V <sub>ECO</sub>	Emitter-to-Collector Voltage	7	V
PD	Detector Power Dissipation @ T <sub>A</sub> = 25°C	150	mW
	Derate Above 25°C	1.76	mW/°C

Stresses exceeding those listed in the Maximum Ratings table may damage the device. If any of these limits are exceeded, device functionality should not be assumed, damage may occur and reliability may be affected.

#### **ELECTRICAL CHARACTERISTICS – INDIVIDUAL COMPONENT CHARACTERISTICS**

(T<sub>A</sub> = 25°C unless otherwise noted)

Symbol	Parameter	Test Conditions	Min	Тур	Max	Unit
EMITTER						
V <sub>F</sub>	Input Forward Voltage	I <sub>F</sub> = 10 mA	-	1.18	1.50	V
I <sub>R</sub>	Reverse Leakage Current	V <sub>R</sub> = 6.0 V	-	0.001	10	μΑ
DETECTOR						
BV <sub>CEO</sub>	Collector-to-Emitter Breakdown Voltage	I <sub>C</sub> = 1.0 mA, I <sub>F</sub> = 0	30	100	-	V
BV <sub>CBO</sub>	Collector-to-Base Breakdown Voltage	I <sub>C</sub> = 100 μA, I <sub>F</sub> = 0	70	120	-	V
BV <sub>ECO</sub>	Emitter-to-Collector Breakdown Voltage	I <sub>E</sub> = 100 μA, I <sub>F</sub> = 0	7	10	-	V
I <sub>CEO</sub>	Collector-to-Emitter Dark Current	V <sub>CE</sub> = 10 V, I <sub>F</sub> = 0	-	1	50	nA
I <sub>CBO</sub>	Collector-to-Base Dark Current	V <sub>CB</sub> = 10 V	-	-	20	nA
C <sub>CE</sub>	Capacitance	V <sub>CE</sub> = 0 V, f = 1 MHz	-	8	-	pF

Product parametric performance is indicated in the Electrical Characteristics for the listed test conditions, unless otherwise noted. Product performance may not be indicated by the Electrical Characteristics if operated under different conditions.

# $\label{eq:constraint} \textbf{ELECTRICAL CHARACTERISTICS} - \textbf{TRANSFER CHARACTERISTICS} \ (T_A = 25^{\circ} C \ \text{unless otherwise noted})$

Symbol	Parameter	Test Conditions	Device	Min	Тур	Max	Unit	
DC CHARAC	DC CHARACTERISTICS							
CTR	Current Transfer Ratio, Collector-to-Emitter	I <sub>F</sub> = 10 mA, V <sub>CE</sub> = 10 V	4N35M, 4N36M, 4N37M	100	-	-	%	
	Collector-to-Emiller		4N25M, 4N26M	20	-	-		
			4N27M, 4N28M	10	-	-		
		$I_F = 10 \text{ mA}, V_{CE} = 10 \text{ V}, \\ T_A = -55^{\circ}\text{C}$	4N35M, 4N36M, 4N37M	40	_	-		
		$I_F = 10 \text{ mA}, V_{CE} = 10 \text{ V}, T_A = +100^{\circ}\text{C}$	4N35M, 4N36M, 4N37M	40	-	-		
V <sub>CE (SAT)</sub>	Collector-to-Emitter Saturation Voltage	I <sub>C</sub> = 2 mA, I <sub>F</sub> = 50 mA	4N25M, 4N26M, 4N27M, 4N28M	-	-	0.5	V	
		I <sub>C</sub> = 0.5 mA, I <sub>F</sub> = 10 mA	4N35M, 4N36M, 4N37M	-	-	0.3	]	

#### AC CHARACTERISTIC

T <sub>ON</sub>	Non-Saturated Turn-on Time	$\begin{array}{l} \text{I}_{\text{F}} = 10 \text{ mA}, \text{ V}_{\text{CC}} = 10 \text{ V}, \\ \text{R}_{\text{L}} = 100 \ \Omega \ \ \text{(Figure 11)} \end{array}$	4N25M, 4N26M, 4N27M, 4N28M	-	2	-	μs
		$\begin{array}{l} \text{I}_{\text{C}} = 2 \text{ mA}, \text{ V}_{\text{CC}} = 10 \text{ V}, \\ \text{R}_{\text{L}} = 100 \ \Omega \ \ (\text{Figure 11}) \end{array}$	4N35M, 4N36M, 4N37M	-	2	10	
T <sub>OFF</sub>	Turn-off Time	$\begin{array}{l} I_F = 10 \text{ mA}, \text{ V}_{CC} = 10 \text{ V}, \\ \text{R}_L = 100 \ \Omega  (\text{Figure 11}) \end{array}$	4N25M, 4N26M, 4N27M, 4N28M	-	2	_	μs
		$    I_C = 2 \text{ mA, } V_{CC} = 10 \text{ V,} \\ R_L = 100 \ \Omega  (\text{Figure 11}) $	4N35M, 4N36M, 4N37M	-	2	10	

Product parametric performance is indicated in the Electrical Characteristics for the listed test conditions, unless otherwise noted. Product performance may not be indicated by the Electrical Characteristics if operated under different conditions.

#### ELECTRICAL CHARACTERISTICS - ISOLATION CHARACTERISTICS (T<sub>A</sub> = 25°C unless otherwise noted)

Symbol	Parameter	Test Conditions	Min	Тур	Max	Unit
V <sub>ISO</sub>	Input-Output Isolation Voltage	t = 1 Minute	4170	-	-	VAC <sub>RMS</sub>
C <sub>ISO</sub>	Isolation Capacitance	V <sub>I-O</sub> = 0 V, f = 1 MHz	-	0.2	-	pF
R <sub>ISO</sub>	Isolation Resistance	$V_{I-O}$ = ±500 VDC, $T_A$ = 25°C	10 <sup>11</sup>	-	-	Ω

Product parametric performance is indicated in the Electrical Characteristics for the listed test conditions, unless otherwise noted. Product performance may not be indicated by the Electrical Characteristics if operated under different conditions.

## **TYPICAL PERFORMANCE CURVES**

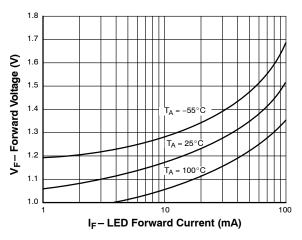


Figure 1. LED Forward Voltage vs. Forward Current

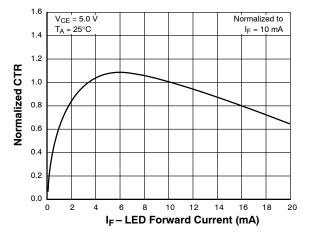


Figure 2. Normalized CTR vs. Forward Current

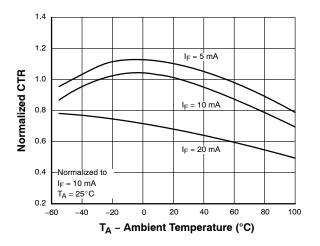


Figure 3. Normalized CTR vs. Ambient Temperature

 $I_F = 5 mA$ 

I<sub>F</sub> = 10 mA

1.0 0.9

0.8

0.7

0.6

0.5

0.4 0.3

0.2

0.1

0.0

10

(CTR<sub>RBE</sub> / CTR<sub>RBE</sub>(OPEN))

Normalized CTR

I<sub>F</sub> = 20 m/

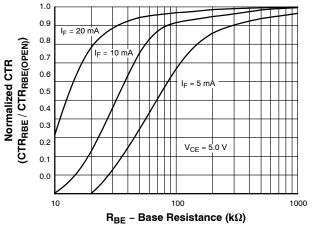


Figure 4. CTR vs. RBE (Unsaturated)

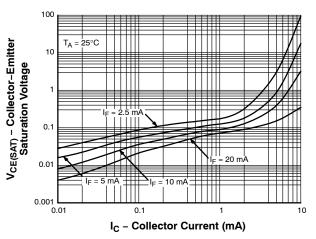
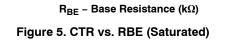


Figure 6. Collector–Emitter Saturation Voltage vs. Collector Current



100

www.onsemi.com

1000

#### TYPICAL PERFORMANCE CURVES (continued)

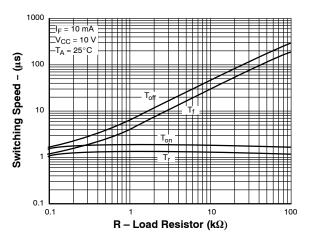


Figure 7. Switching Speed vs. Load Resistor

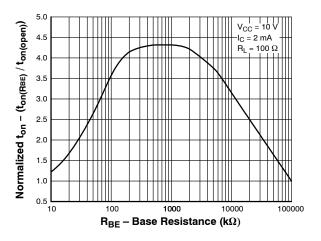


Figure 8. Normalized ton vs. RBE

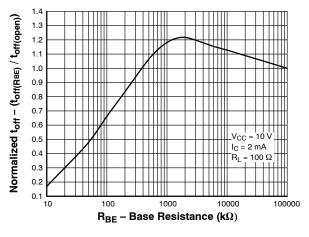


Figure 9. Normalized toff vs. RBE

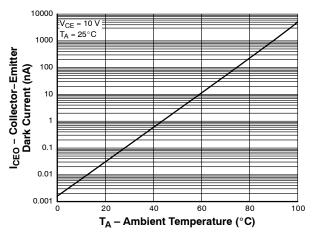
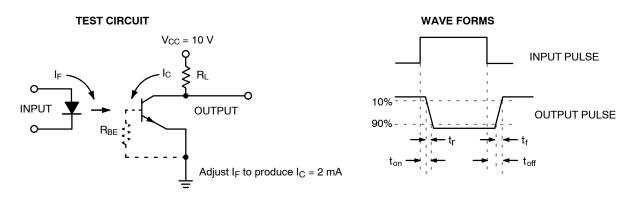


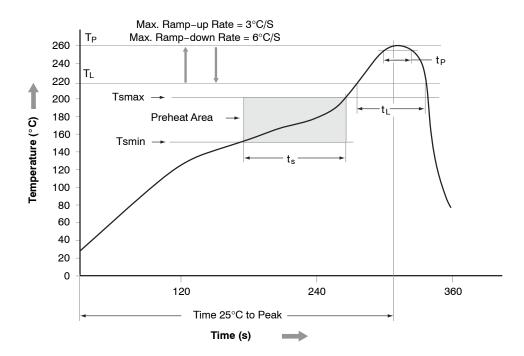
Figure 10. Dark Current vs. Ambient Temperature

#### SWITCHING TIME TEST CIRCUIT AND WAVEFORMS





### **REFLOW PROFILE**



Profile Feature	Pb-Free Assembly Profile
Temperature Min. (Tsmin)	150°C
Temperature Max. (Tsmax)	200°C
Time (t <sub>S</sub> ) from (Tsmin to Tsmax)	60–120 seconds
Ramp-up Rate (t <sub>L</sub> to t <sub>P</sub> )	3°C/second max.
Liquidous Temperature (T <sub>L</sub> )	217°C
Time (t $_{L}$ ) Maintained Above (T $_{L}$ )	60–150 seconds
Peak Body Package Temperature	260°C +0°C / -5°C
Time (t <sub>P</sub> ) within 5°C of 260°C	30 seconds
Ramp-down Rate ( $T_P$ to $T_L$ )	6°C/second max.
Time 25°C to Peak Temperature	8 minutes max.

Figure 12. Reflow Profile

#### **ORDERING INFORMATION** (Note 2)

Part Number	Package	Shipping <sup>†</sup>
4N25M	DIP 6-Pin	50 Units / Tube
4N25SM	SMT 6-Pin (Lead Bend)	50 Units / Tube
4N25SR2M	SMT 6-Pin (Lead Bend)	1000 Units / Tape & Reel
4N25VM	DIP 6-Pin, DIN EN/IEC60747-5-5 Option	50 Units / Tube
4N25SVM	SMT 6-Pin (Lead Bend), DIN EN/IEC60747-5-5 Option	50 Units / Tube
4N25SR2VM	SMT 6-Pin (Lead Bend), DIN EN/IEC60747-5-5 Option	1000 Units / Tape & Reel
4N25TVM	DIP 6-Pin, 0.4" Lead Spacing, DIN EN/IEC60747-5-5 Option	50 Units / Tube

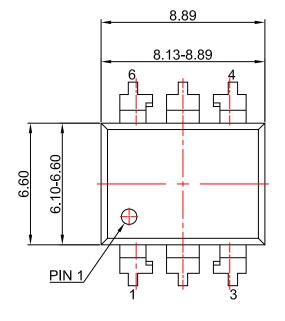
+For information on tape and reel specifications, including part orientation and tape sizes, please refer to our Tape and Reel Packaging Specifications Brochure, BRD8011/D.

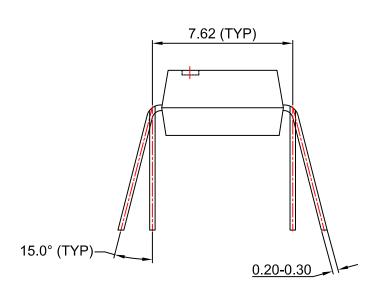
The product orderable part number system listed in this table also applies to the 4N26M, 4N27M, 4N28M, 4N35M, 4N36M, and 4N37M devices.

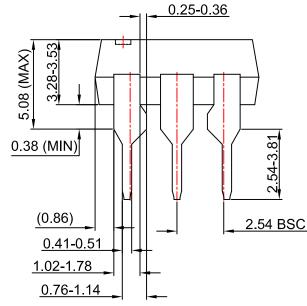


PDIP6 8.51x6.35, 2.54P CASE 646BX ISSUE O

DATE 31 JUL 2016







#### NOTES:

- A) NO STANDARD APPLIES TO THIS PACKAGE.
- B) ALL DIMENSIONS ARE IN MILLIMETERS.
- C) DIMENSIONS ARE EXCLUSIVE OF BURRS, MOLD FLASH, AND TIE BAR EXTRUSION

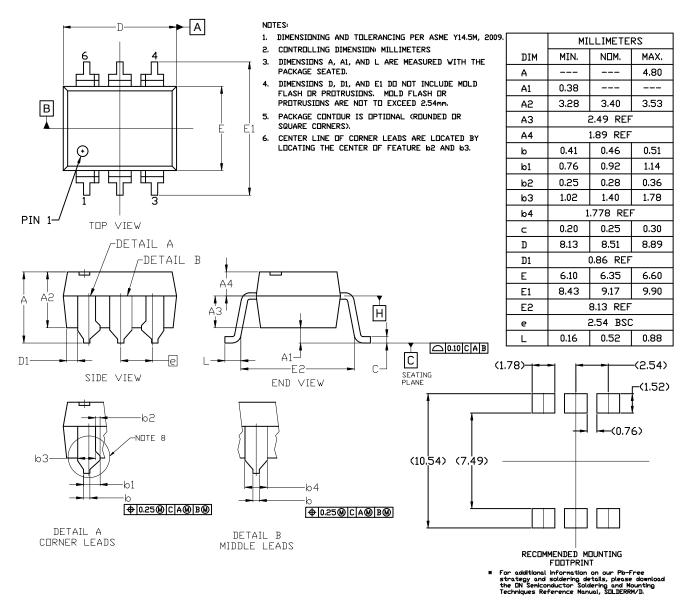
DOCUMENT NUMBER:	98AON13449G	Electronic versions are uncontrolled except when accessed directly from the Document Reposite Printed versions are uncontrolled except when stamped "CONTROLLED COPY" in red.			
DESCRIPTION:	PDIP6 8.51X6.35, 2.54P		PAGE 1 OF 1		
ON Semiconductor and $\textcircled{0}$ are trademarks of Semiconductor Components Industries, LLC dba ON Semiconductor or its subsidiaries in the United States and/or other countries. ON Semiconductor reserves the right to make changes without further notice to any products herein. ON Semiconductor makes no warranty, representation or guarantee regarding the suitability of its products for any particular purpose, nor does ON Semiconductor assume any liability arising out of the application or use of any product or circuit, and specifically disclaims any and all liability, including without limitation special consequential or includent damages. ON Semiconductor does not convert any lisense under its patent in the tor the					

rights of others.

# ON

#### PDIP6 8.51x6.35, 2.54P CASE 646BY ISSUE A

#### DATE 15 JUL 2019

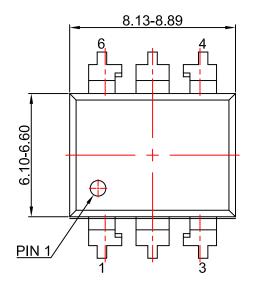


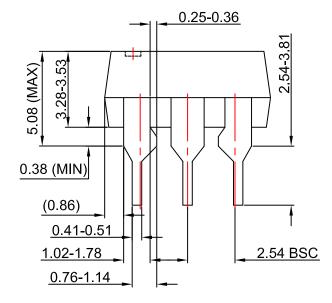
DOCUMENT NUMBER:	98AON13450G	Electronic versions are uncontrolled except when accessed directly from the Document Repositor Printed versions are uncontrolled except when stamped "CONTROLLED COPY" in red.			
DESCRIPTION:	PDIP6 8.51x6.35, 2.54P		PAGE 1 OF 1		
ON Semiconductor and (III) are trademarks of Semiconductor Components Industries, LLC dba ON Semiconductor or its subsidiaries in the United States and/or other countries. ON Semiconductor reserves the right to make changes without further notice to any products herein. ON Semiconductor makes no warranty, representation or guarantee regarding the suitability of its products for any particular purpose, nor does ON Semiconductor assume any liability arising out of the application or use of any product or circuit, and specifically disclaims any and all liability, including without limitation special, consequential or incidental damages. ON Semiconductor does not convey any license under its patent rights nor the					

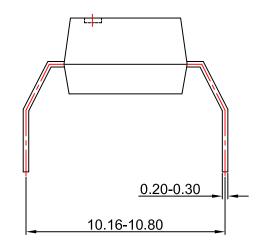


PDIP6 8.51x6.35, 2.54P CASE 646BZ ISSUE O

DATE 31 JUL 2016







NOTES:

- A) NO STANDARD APPLIES TO THIS PACKAGE.
- B) ALL DIMENSIONS ARE IN MILLIMETERS.
- C) DIMENSIONS ARE EXCLUSIVE OF BURRS, MOLD FLASH, AND TIE BAR EXTRUSION

DOCUMENT NUMBER:	98AON13451G	Electronic versions are uncontrolled except when accessed directly from the Document Repositor Printed versions are uncontrolled except when stamped "CONTROLLED COPY" in red.				
DESCRIPTION:	PDIP6 8.51X6.35, 2.54P PAGE		PAGE 1 OF 1			
the suitability of its products for any pa	ON Semiconductor and    ON Semiconductor reserves the right to make changes without further notice to any products herein. ON Semiconductor makes no warranty, representation or guarantee regarding the suitability of its products for any particular purpose, nor does ON Semiconductor assume any liability arising out of the application or use of any product or circuit, and specifically disclaims any and all liability, including without limitation special, consequential or incidental damages. ON Semiconductor does not convey any license under its patent rights nor the					

onsemi, ONSEMI, and other names, marks, and brands are registered and/or common law trademarks of Semiconductor Components Industries, LLC dba "onsemi" or its affiliates and/or subsidiaries in the United States and/or other countries. onsemi owns the rights to a number of patents, trademarks, copyrights, trade secrets, and other intellectual property. A listing of onsemi's product/patent coverage may be accessed at <u>www.onsemi.com/site/pdf/Patent-Marking.pdf</u>. onsemi reserves the right to make changes at any time to any products or information herein, without notice. The information herein is provided "as-is" and onsemi makes no warranty, representation or guarantee regarding the accuracy of the information, product features, availability, functionality, or suitability of its products for any particular purpose, nor does onsemi assume any liability arising out of the application or use of any product or circuit, and specifically disclaims any and all liability, including without limitation special, consequential or indental damages. Buyer is responsible for its products and applications using onsemi products, including compliance with all laws, regulations and safety requirements or standards, regardless of any support or applications information provided by onsemi. "Typical" parameters which may be provided in onsemi data sheets and/or specifications can and do vary in different applications and actual performance may vary over time. All operating parameters, including "Typicals" must be validated for each customer application by customer's technical experts. onsemi does not convey any license under any of its intellectual property rights nor the rights of others. onsemi products are not designed, intended, or authorized for use as a critical component in life support systems or any FDA Class 3 medical devices or medical devices with a same or similar classification. Buyer shall indemnify and hold onsemi and its officers, employees, subsidiaries, affiliates, and distributors harmless against all claims, costs,

#### ADDITIONAL INFORMATION

TECHNICAL PUBLICATIONS:

Technical Library: www.onsemi.com/design/resources/technical-documentation onsemi Website: www.onsemi.com ONLINE SUPPORT: <u>www.onsemi.com/support</u> For additional information, please contact your local Sales Representative at www.onsemi.com/support/sales